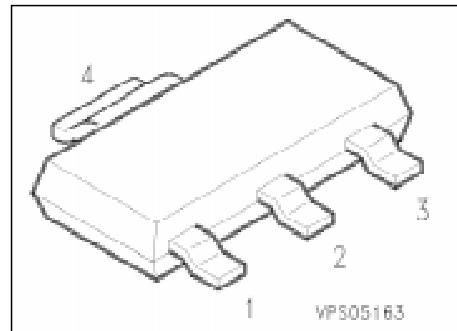


NPN Silicon Darlington Transistors

**BCP 29
BCP 49**

- For general AF applications
- High collector current
- High current gain
- Complementary types: BCP 28/48 (PNP)



Type	Marking	Ordering Code (tape and reel)	Pin Configuration	Package ¹⁾
BCP 29	BCP 29	Q62702-C2136		SOT-223
BCP 49	BCP 49	Q62702-C2137		

Maximum Ratings

Parameter	Symbol	Values		Unit
		BCP 29	BCP 49	
Collector-emitter voltage	V_{CE0}	30	60	V
Collector-base voltage	V_{CB0}	40	80	
Emitter-base voltage	V_{EB0}	10	10	
Collector current	I_C	500		mA
Peak collector current	I_{CM}	800		
Base current	I_B	100		
Peak base current	I_{BM}	200		
Total power dissipation, $T_S = 124^\circ\text{C}^2$	P_{tot}	1.5		W
Junction temperature	T_j	150		$^\circ\text{C}$
Storage temperature range	T_{stg}	– 65 ... + 150		

Thermal Resistance

Junction - ambient ²⁾	$R_{th JA}$	≤ 75	K/W
Junction - soldering point	$R_{th JS}$	≤ 17	

¹⁾ For detailed information see chapter Package Outlines.

²⁾ Package mounted on epoxy pcb 40 mm × 40 mm × 1.5 mm/6 cm² Cu.

Electrical Characteristicsat $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CE}0}$	30 60	— —	— —	V
Collector-base breakdown voltage $I_C = 100 \mu\text{A}, I_B = 0$	$V_{(\text{BR})\text{CB}0}$	40 80	— —	— —	
Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EB}0}$	10	—	—	
Collector-base cutoff current $V_{CB} = 30 \text{ V}, I_E = 0$	I_{CBO}	BCP 29 BCP 49	— — — —	100 100 10 10	nA nA μA μA
Emitter-base cutoff current $V_{EB} = 4 \text{ V}, I_C = 0$	I_{EBO}	—	—	100	nA
DC current gain ¹⁾ $I_C = 100 \mu\text{A}, V_{CE} = 1 \text{ V}$	h_{FE}	BCP 29 BCP 49	4000 2000 10000 4000 20000 10000 4000 2000	— — — — — — — —	—
Collector-emitter saturation voltage $I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$	V_{CESat}	—	—	1.0	V
Base-emitter saturation voltage $I_C = 100 \text{ mA}, I_B = 0.1 \text{ mA}$	V_{BESat}	—	—	1.5	

¹⁾ Pulse test conditions: $t \leq 300 \mu\text{s}$, $D = 2\%$.

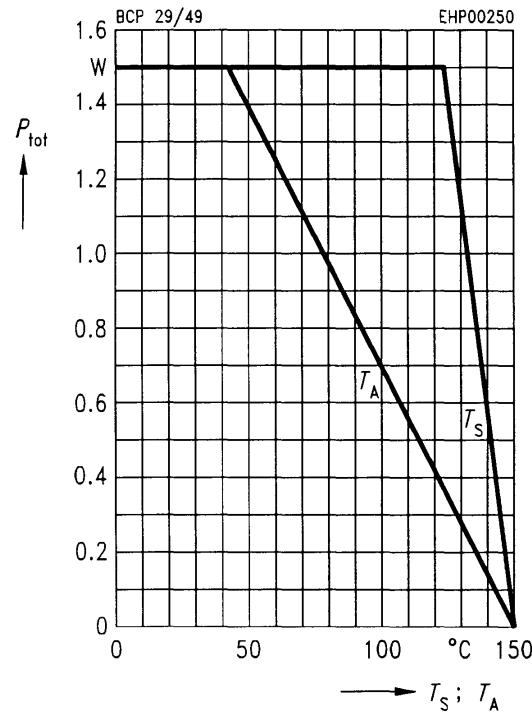
Electrical Characteristicsat $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

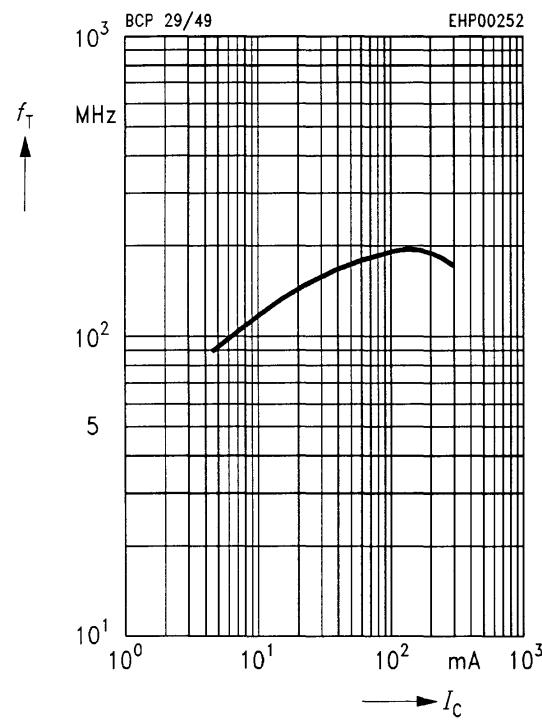
AC characteristics

Transition frequency $I_C = 50 \text{ mA}, V_{CE} = 5 \text{ V}, f = 100 \text{ MHz}$	f_T	—	200	—	MHz
Output capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{obo}	—	6.5	—	pF

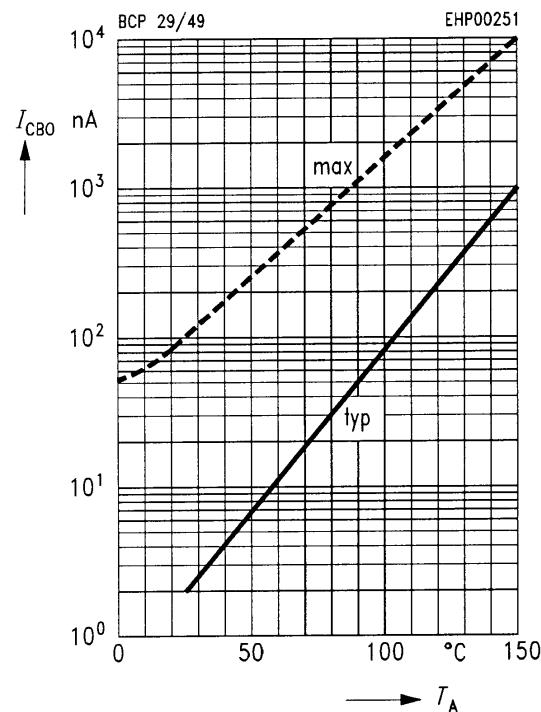
Total power dissipation $P_{\text{tot}} = f(T_A^*; T_S)$
 * Package mounted on epoxy



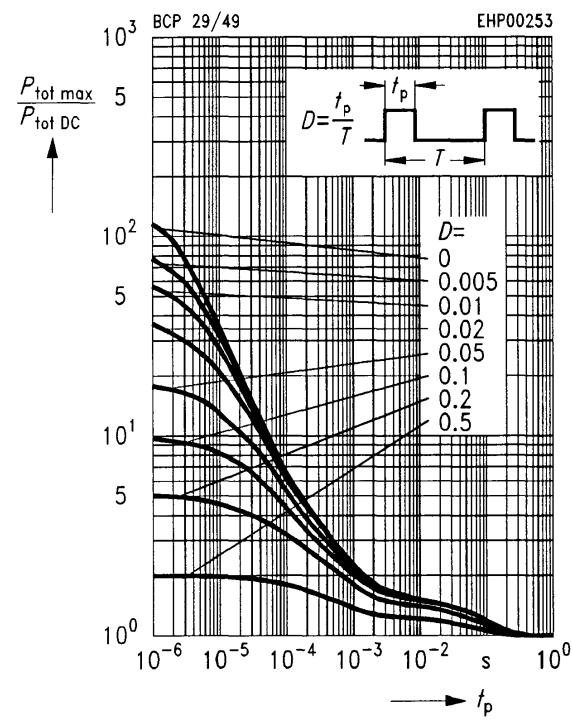
Transition frequency $f_T = f(I_C)$
 $V_{CE} = 5$ V



Collector cutoff current $I_{CB0} = f(T_A)$
 $V_{CB} = V_{CE \text{ max}}$

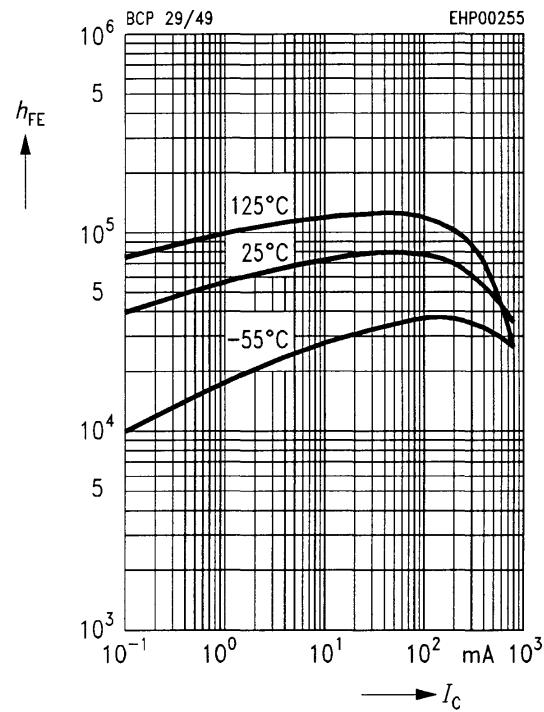


Permissible pulse load $P_{\text{tot max}}/P_{\text{tot DC}} = f(t_p)$



DC current gain $h_{FE} = f(I_C)$

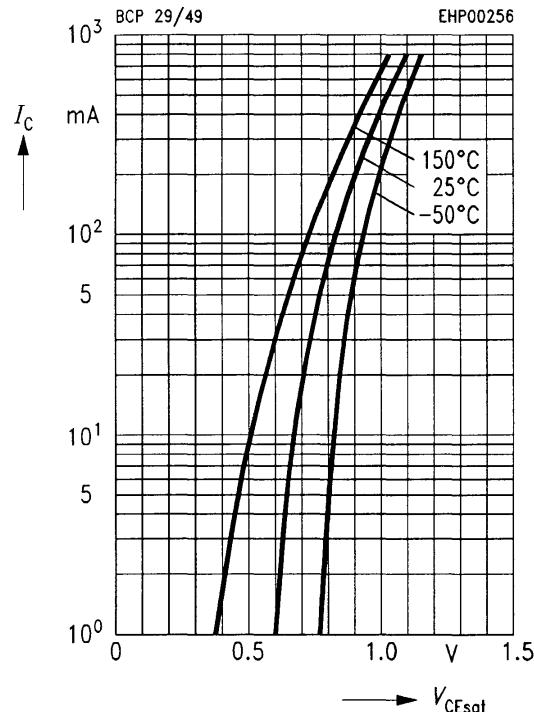
$V_{CE} = 10 \text{ V}$



Collector-emitter saturation voltage

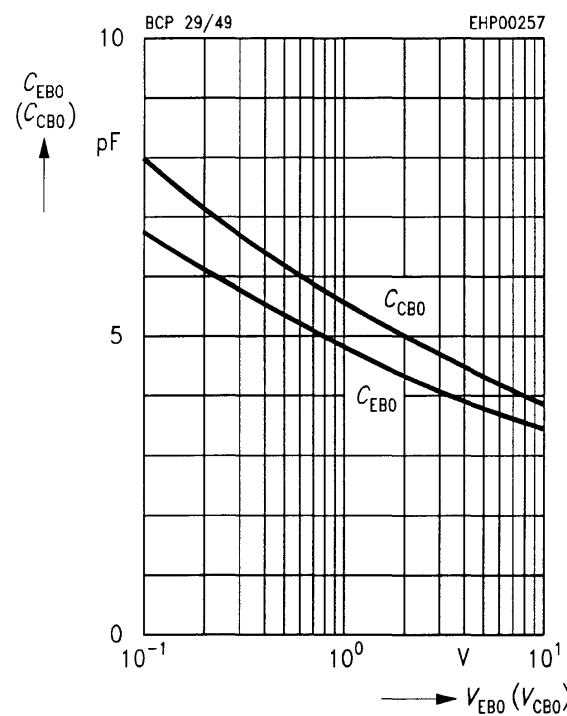
$$I_C = f(V_{CEsat})$$

$h_{FE} = 1000$



Collector-base capacitance $C_{CB0} = f(V_{CB0})$

Emitter-base capacitance $C_{EB0} = f(V_{EB0})$



Base-emitter saturation voltage

$$I_C = f(V_{BEsat})$$

$h_{FE} = 1000$

